



产品中有害物质的名称及含有的信息表

Table of information on names and presence of hazardous substances in the product

部件名称 Component name	有害物质 Hazardous Substance									
	铅 (Pb)	汞 (Hg)	镉 (Cr)	六价铬或 (Cr6+)	多溴联苯 (PBBs)	多溴二苯醚 (PBDEs)	邻苯二甲酸二正丁酯 (DBP)	邻苯二甲酸二异丁酯 (DIBP)	邻苯二甲酸丁酯 (BBP)	邻苯二甲酸二(2-乙基)己酯 (DEHP)
金属部件 (包括紧固件) Metal Parts (including fasteners)	×	○	○	○	○	○	○	○	○	○
印刷电路板组件和元件 Printed circuit assemblies and components	×	○	○	○	○	○	○	○	○	○
缆线和缆线组件 Cables & Cable Assemblies	×	○	○	○	○	○	○	○	○	○
塑料和聚合物部件 Plastic and Polymeric parts	○	○	○	○	○	○	○	○	○	○
显示器, 包含灯泡 Displays including lamps	×	○	○	○	○	○	○	○	○	○
除印刷电路板外的其他 电子组件 Other electronic assembly beside PCB	×	○	○	○	○	○	○	○	○	○
光学玻璃材料 Optical glass materials	×	○	×	○	○	○	○	○	○	○
干电池 Batteries	○	○	○	○	○	○	○	○	○	○

注 1: ○: 表示该有害物质在该部件所有均质材料中的含量均不超出电器电子产品有害物质限制使用国家标准要求。

×: 表示该有害物质至少在该部件的某一均质材料中的含量超出电器电子产品有害物质限制使用国家标准要求。

Note 1: ○ denotes that the content of said hazardous substance in all of the homogeneous materials in the said component does not exceed the limits given in the national standard regarding restricted use of hazardous substances in electrical and electronic products.

× denotes that the content of said hazardous substance in at least one of the homogeneous materials in the said component exceeds the limits given in the national standard regarding restricted use of hazardous substances in electrical and electronic product.

注 2: 以上未列出的部件, 表明其有害物质含量均不超出电器电子产品有害物质限制使用国家标准要求。

以销售日期为准, 此表显示在 “思科系统公司” 的电子信息技术产品中何处存在这些有毒有害物质。请注意, 并非上列所有部件都包含在内装产品中。

Note 2: Those components not listed above indicate that the content of all hazardous substances contained therein does not exceed the limits given in the national standard regarding restricted use of hazardous substances in electrical and electronic products.

This table shows where these toxic and hazardous substances are present in parts of Cisco Systems' electronic information products as of the date of sale. Please note that not all parts listed above are included in the product.